



# FFPF10UP60S

## 10 A, 600 V Ultrafast Diode

### Features

- Ultrafast Recovery  $t_{rr} = 40 \text{ ns}$  (@  $I_F = 1 \text{ A}$ )
- Max Forward Voltage,  $V_F = 2.2 \text{ V}$  (@  $T_C = 25^\circ\text{C}$ )
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

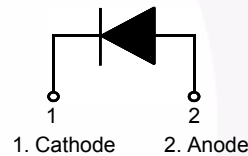
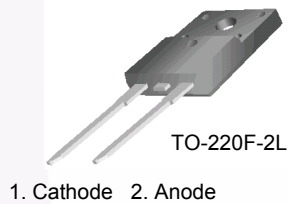
### Applications

- General Purpose
- SMPS, Power Switching Circuits
- Free-Wheeling Diode for Motor Application
- Welder, UPS

### Description

The FFPF10UP60S is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applications as welder and UPS application.

### Pin Assignments



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol         | Parameter   | Rating       | Unit             |
|----------------|---|--------------|------------------|
| $V_{RRM}$      | Peak Repetitive Reverse Voltage                                 | 600          | V                |
| $V_{RWM}$      | Working Peak Reverse Voltage                                    | 600          | V                |
| $I_{F(AV)}$    | Average Rectified Forward Current @ $T_C = 60^\circ\text{C}$    | 10           | A                |
| $I_{FSM}$      | Non-repetitive Peak Surge Current<br>60Hz Single Half-Sine Wave | 50           | A                |
| $T_J, T_{STG}$ | Operating Junction and Storage Temperature                      | - 65 to +175 | $^\circ\text{C}$ |

### Thermal Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol          | Parameter                                    | Max. | Unit               |
|-----------------|--|------|--------------------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case | 4.5  | $^\circ\text{C/W}$ |

### Package Marking and Ordering Information

| Part Number   | Top Mark    | Package    | Packing Method | Reel Size | Tape Width | Quantity |
|---------------|-------------|------------|----------------|-----------|------------|----------|
| FFPF10UP60STU | FFPF10UP60S | TO-220F-2L | Tube           | N/A       | N/A        | 30       |

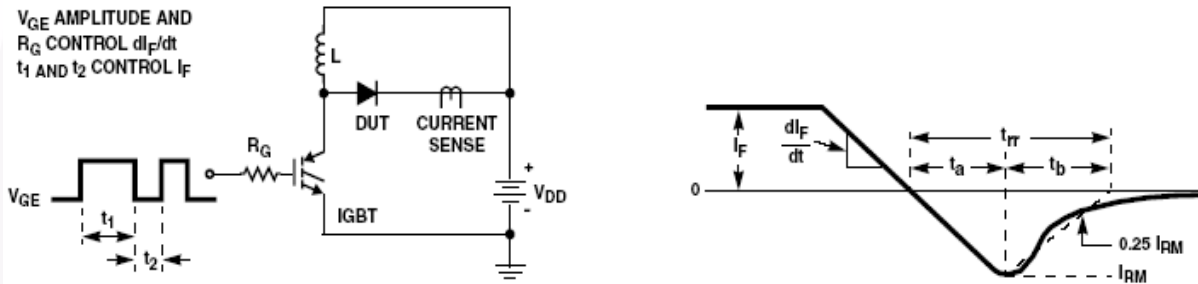
### Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

| Parameter   | Conditions   | Min.  | Typ.        | Max.            | Unit          |
|---|--|---|-------------|-----------------|---------------|
| V <sub>F</sub> <sup>1</sup>                           | Maximum Instantaneous Forward Voltage<br>I <sub>F</sub> = 10 A<br>I <sub>F</sub> = 10 A  | T <sub>C</sub> = 25 °C<br>T <sub>C</sub> = 100 °C | -<br>-      | 2.2<br>2.0      | V             |
| I <sub>R</sub> <sup>1</sup>                           | Maximum Instantaneous Reverse Current<br>@ rated V <sub>R</sub>  | T <sub>C</sub> = 25 °C<br>T <sub>C</sub> = 100 °C | -<br>-      | 100<br>500      | μA            |
| t <sub>rr</sub>                                       | I <sub>F</sub> = 1 A, di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 30 V  | T <sub>C</sub> = 25 °C                            | -           | 25              | ns            |
| t <sub>rr</sub><br>I <sub>rr</sub><br>Q <sub>rr</sub> | Reverse Recovery Time<br>Reverse Recovery Current<br>Reverse Recovery Charge<br>(I <sub>F</sub> = 8 A, di <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 390 V) |   | -<br>-<br>- | 34<br>1.0<br>17 | ns<br>A<br>nC |
| t <sub>rr</sub>                                       | Maximum Reverse Recovery Time<br>(I <sub>F</sub> = 10 A, di <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 390 V)   |   | -           | 58              | ns            |
| W <sub>AVL</sub>                                      | Avalanche Energy (L = 40 mH)   |   | 20          | -               | mJ            |

**Notes:**

1. Pulse : Test Pulse width = 300μs, Duty Cycle = 2%

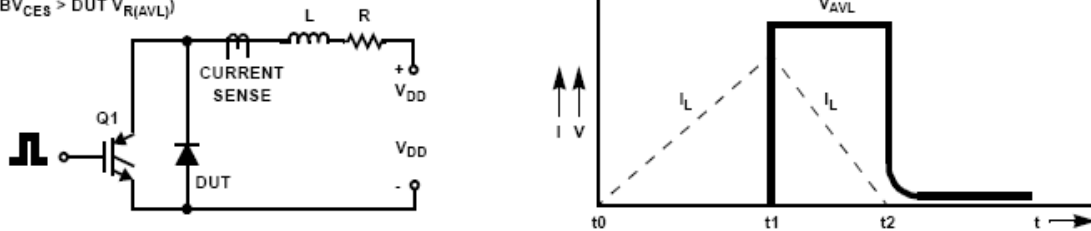
### Test Circuit and Waveforms



**Figure 1. Diode Reverse Recovery Test Circuit & Waveform**

L = 40mH  
R < 0.1Ω  
V<sub>DD</sub> = 50V

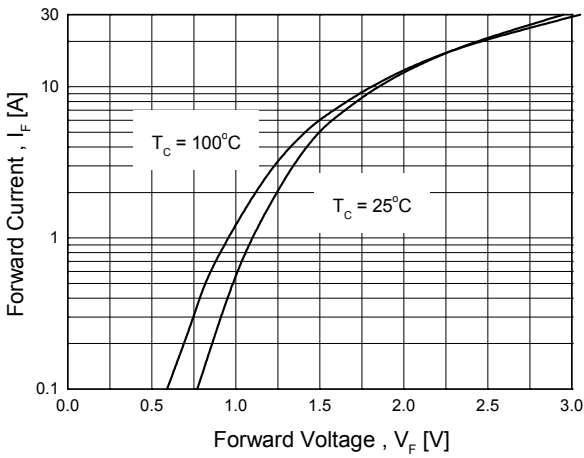
EAVL = 1/2LI<sub>2</sub> [V<sub>R(AVL)</sub>/(V<sub>R(AVL)</sub> - V<sub>DD</sub>)]  
Q1 = IGBT (BV<sub>CES</sub> > DUT V<sub>R(AVL)</sub>)



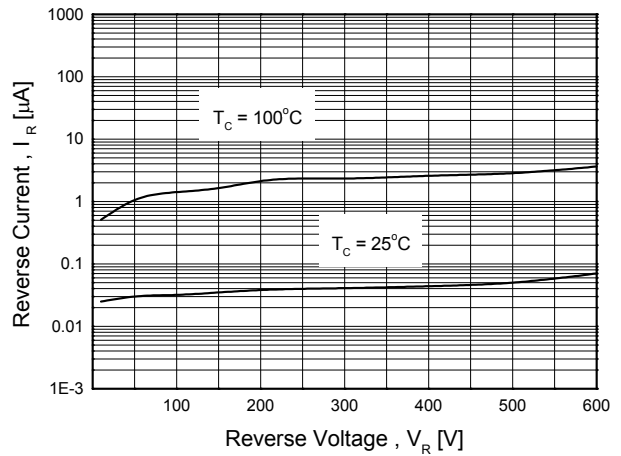
**Figure 2. Unclamped Inductive Switching Test Circuit & Waveform**

**Typical Performance Characteristics**  $T_C = 25^\circ\text{C}$  unless otherwise noted

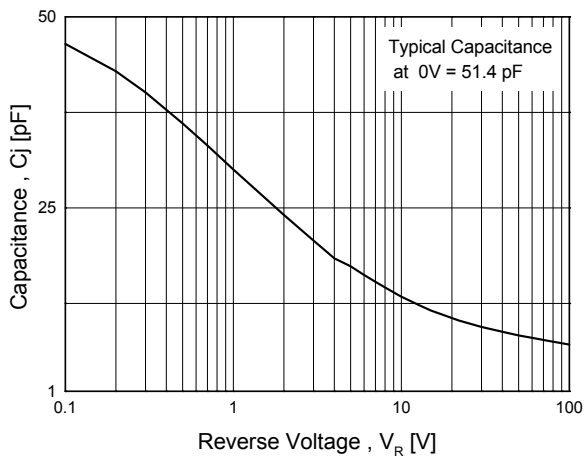
**Figure 3. Typical Forward Voltage Drop**



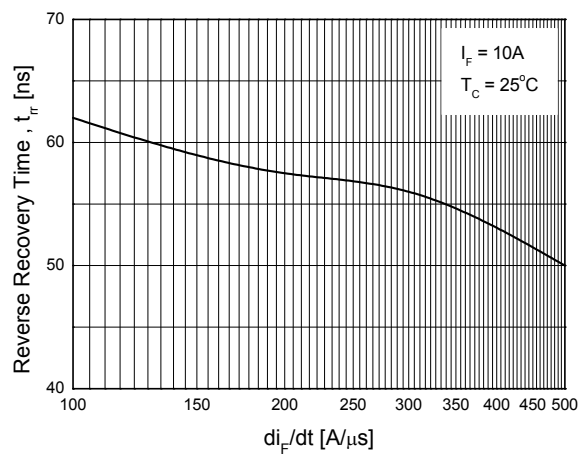
**Figure 4. Typical Reverse Current**



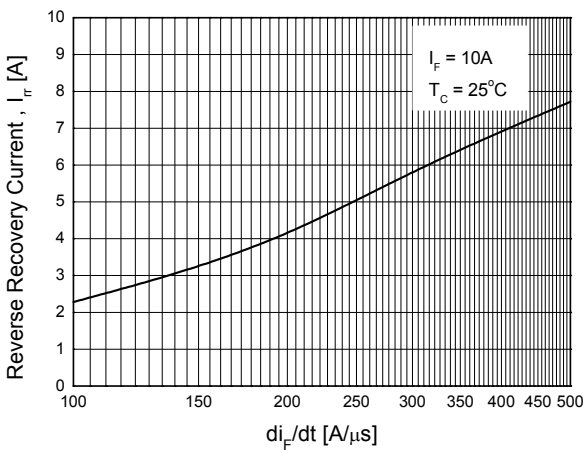
**Figure 5. Typical Junction Capacitance**



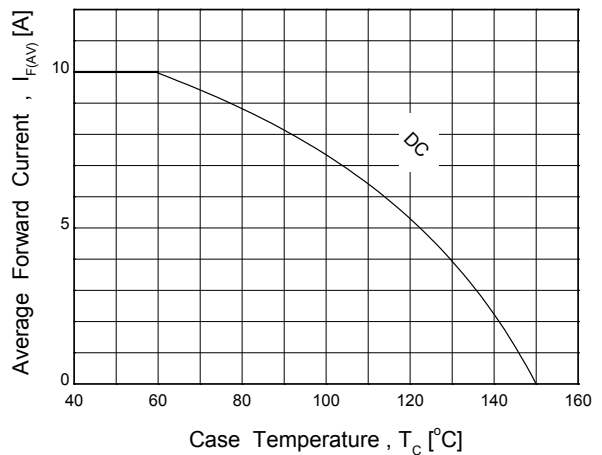
**Figure 6. Typical Reverse Recovery Time**



**Figure 7. Typical Reverse Recovery Current**



**Figure 8. Forward Current Deration Curve**



## Mechanical Dimensions

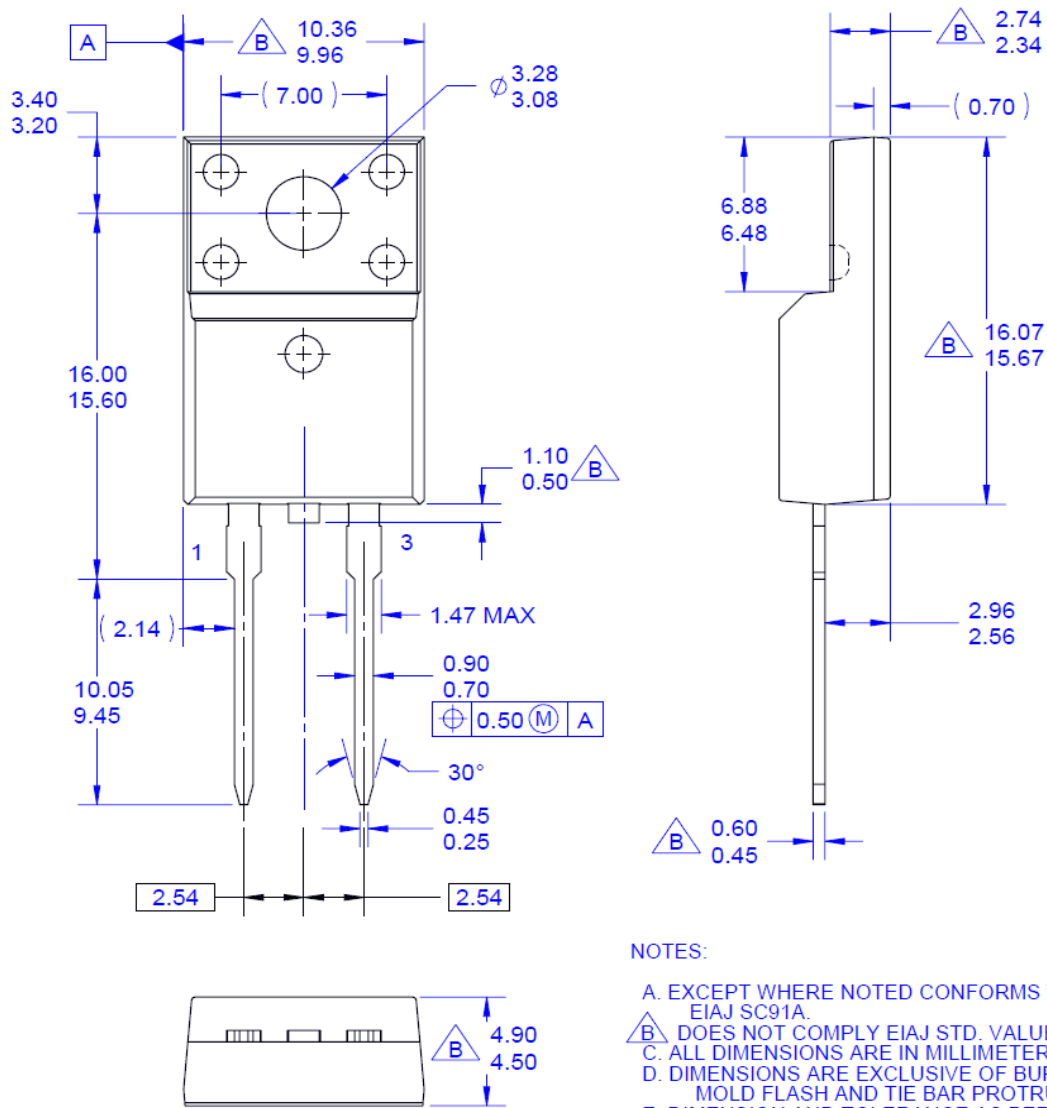


Figure 9. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK

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Rev. I71